

Features

- Ultra-Low capacitance:0.05pF(typ.)
- Low leakage current(<10nA)
- Fast response time(<1ns)
- Bi-directional, single line protection
- IEC 61000-4-2 (ESD Air): 15kV
IEC 61000-4-2 (ESD Contact): 8kV

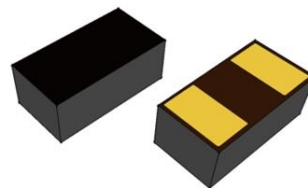
Mechanical Characteristics

- USB 3.0/3.1
- HDMI 1.3/1.4/2.0
- RF Antenna
- SATA and eSATA Interface

Applications

- Smart Phone/Mobile Internet Device
- Laptop/Desktop Computer
- Bi-directional, single line protection
- Antennas (Cell Phones, GPS...)
- High Speed Ethernet
- USB 3.0 and USB 3.1

Dimensions and Pin Configuration



Absolute Maximum Ratings (Tamb=25°C unless otherwise specified)

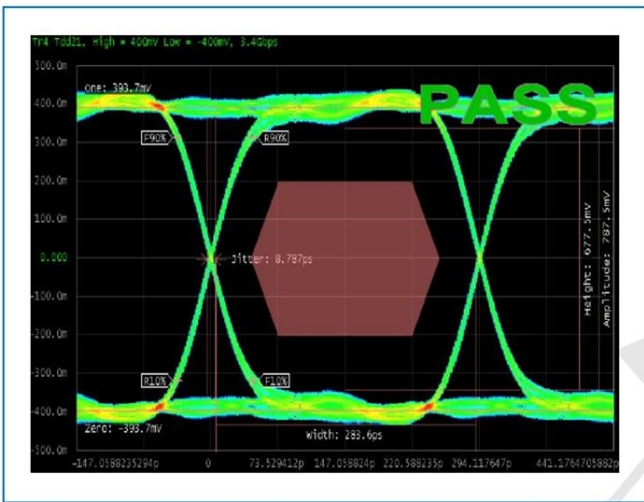
Parameter	Symbol	Value	Unit
ESD per IEC 61000-4-2 (Air) ESD per IEC 61000-4-2 (Contact)	V _{ESD}	±15 ±8	kV
Operating Temperature Range	T _J	-55 to +125	°C
Storage Temperature Range	T _{stg}	-40 to +85	°C

Electrical Characteristics (TA=25°C unless otherwise specified)

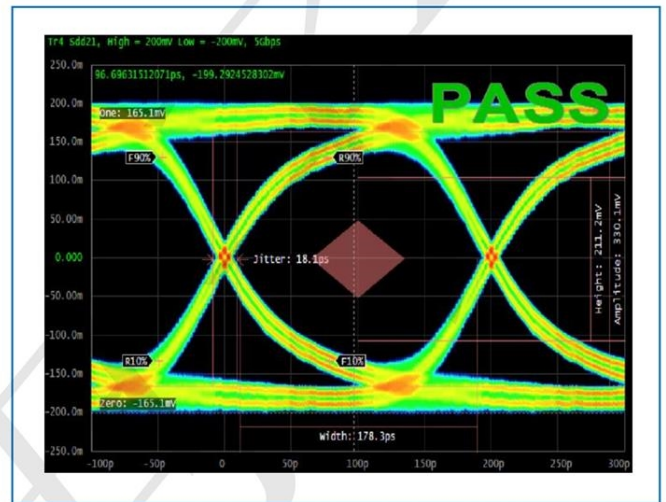
Parameter	Symbol	Min	Typ	Max	Unit	Test Condition
Continuous Operating Voltage	V _{DC}			12	V	
Trigger Voltage	V _T		450		V	IEC61000-4-2 8kV contact discharge
Clamping Voltage	V _C		40		V	IEC61000-4-2 8kV contact discharge
Leakage Current	I _L			10	nA	DC 12V shall be applied on component
Capacitance	C _J		0.05		pF	Measured at 10MHz

PROTECTION PRODUCTS
Typical characteristics

HDMI Mask at 3.4 Gbps



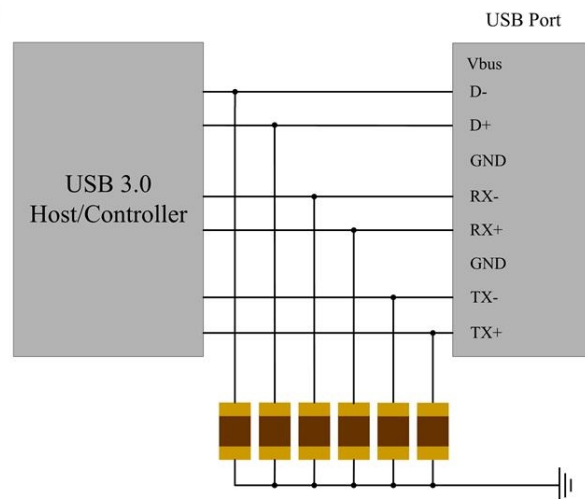
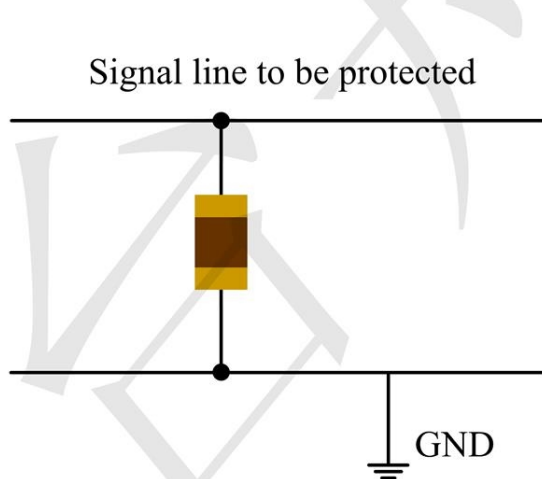
USB3.0 Mask at 5.0 Gbps



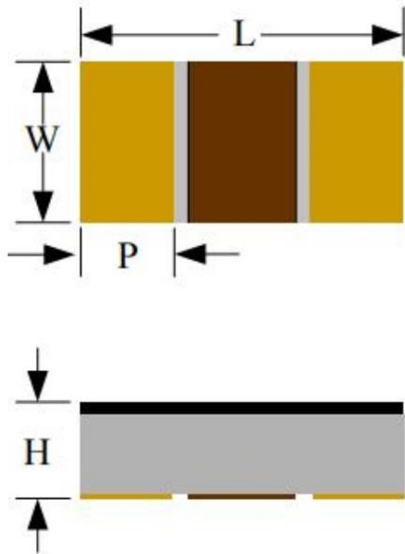
ESD Protection for Signal Line

The PESD0402A is designed for the protection of one bidirectional data line from ESD damage.

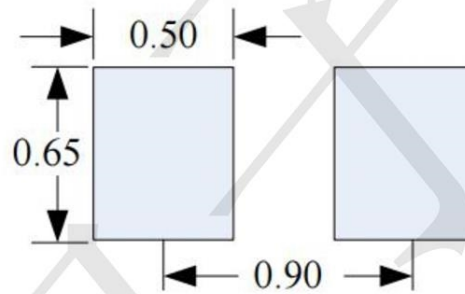
- Place the PESD0402A as close to the input terminal or connector as possible.
- Minimize the path length between the PESD0402A and the protected signal line.
- Use ground planes whenever possible.



Package Dimension



Recommended Solder Pad Footprint



***Sizes in mm**

Notes:

This solder pad layout is for reference purposes only.

Dimension	Unit: Millimeters	
	Min.	Max.
L	0.90	1.10
W	0.42	0.62
p	0.15	0.35
H	0.25	0.45